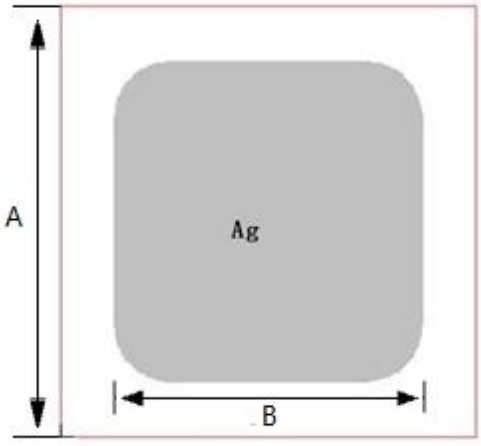

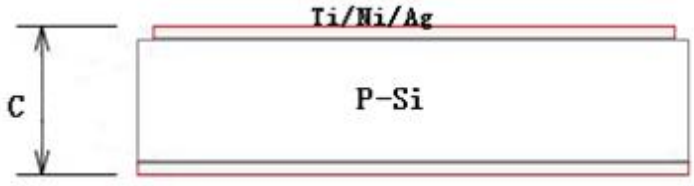

芯片参数

项 目	参数
圆片尺寸	4 英寸
芯片厚度(C)	230±5μm
有效管芯数	3760 粒/片
管芯尺寸(A)	1.4mm
金属尺寸(B)	1.18mm
划道宽度	60μm

电参数（探针测试；T=25℃）

反向击穿电压		反向漏电流		箝位电压	
V_{BR}(V)@ I_T	I_T(mA)	I_R(μA)@V_R	V_R (V)	V_C(V)	@I_{PP}(A)
6.40-7.00	10	＜95	5	＜9.2	43.5

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